

#### Power and Energy: VLSI Design Dr. Tassadaq Hussain Computer Architect Co-Founder PakAsic.com

## **Outline**

#### Power and Energy Dynamic Power Static Power



## Power and Energy

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**3**

#### Power is drawn from a voltage source attached to the  $V_{DD}$  pin(s) of a chip.

Instantaneous Power:

Energy:

Average Power:

# Power in Circuit Elements

 $P_{VDD}(t) = I_{DD}(t) V_{DD}$ 



$$
P_R(t) = \frac{V_R^2(t)}{R} = I_R^2(t)R
$$

 $V_R \leqslant V_R$ 

$$
E_C = \int_0^\infty I(t) V(t) dt = \int_0^\infty C \frac{dV}{dt} V(t) dt
$$
  
= 
$$
C \int_0^{V_C} V(t) dV = \frac{1}{2} C V_C^2
$$

$$
\begin{array}{c}\n+ \\
\nabla_C \leftarrow C \quad \downarrow I_C = C \quad \text{d}V/\text{d}t\n\end{array}
$$

## Charging a Capacitor

When the gate output rises Energy stored in capacitor is

$$
E_C = \frac{1}{2} C_L V_{DD}^2
$$

But energy drawn from the supply is

$$
E_{\text{vDD}} = \int_{0}^{\infty} I(t) V_{\text{DD}} dt = \int_{0}^{\infty} C_{L} \frac{dV}{dt} V_{\text{DD}} dt
$$

$$
= C_{L} V_{\text{DD}} \int_{0}^{V_{\text{DD}}} dV = C_{L} V_{\text{DD}}^{2}
$$



Half the energy from  $V_{DD}$  is dissipated in the pMOS transistor as heat, other half stored in capacitor

When the gate output falls

Energy in capacitor is dumped to GND

Dissipated as heat in the nMOS transistor

# Switching Power





## Activity Factor

Suppose the system clock frequency = f Let  $f_{sw} = \alpha f$ , where  $\alpha$  = activity factor If the signal is a clock,  $\alpha = 1$ If the signal switches once per cycle,  $\alpha = \frac{1}{2}$ 

**7**

Dynamic power:  $P_{\text{switching}} = \alpha CV_{DD}^2 f$ 

## Short Circuit Current

When transistors switch, both nMOS and pMOS networks may be momentarily ON at once

Leads to a blip of "short circuit" current.

< 10% of dynamic power if rise/fall times are comparable for input and output We will generally ignore this component

#### Power Dissipation Sources

 $P_{total} = P_{dynamic} + P_{static}$ Dynamic power:  $P_{dynamic} = P_{switching} + P_{shortcircuit}$ Switching load capacitances Short-circuit current Static power:  $P_{static} = (I_{sub} + I_{gate} + I_{junct} + I_{contention})V_{DD}$ Subthreshold leakage Gate leakage Junction leakage Contention current



A digital system-on-chip in a 1 V 65 nm process (with 50 nm drawn channel lengths and  $\lambda = 25$  nm) has 1 billion transistors, of which 50 million are in logic gates and the remainder in memory arrays. The average logic transistor width is 12  $\lambda$  and the average memory transistor width is 4 . The memory arrays are divided into banks and only the necessary bank is activated so the memory activity factor is 0.02. The static CMOS logic gates have an average activity factor of 0.1. Assume each transistor contributes 1 fF/um of gate capacitance and 0.8 fF/um of diffusion capacitance. Neglect wire capacitance for now (though it could account for a large fraction of total power). Estimate the switching power when operating at 1 GHz.

## Dynamic Power Example

1 billion transistor chip 50M logic transistors

- Average width:  $12 \lambda$
- Activity factor  $= 0.1$

950M memory transistors

- Average width:  $4 \lambda$
- Activity factor  $= 0.02$

1.0 V 65 nm process

 $C = 1$  fF/ $\mu$ m (gate) + 0.8 fF/ $\mu$ m (diffusion)

Estimate dynamic power consumption @ 1 GHz. Neglect wire capacitance and short-circuit current.

### **Solution**

 $(50 \times 10^6)(12 \lambda)(0.025 \mu m / \lambda)(1.8 \text{ fF} / \mu m)$  $(950 \times 10^6)(4\lambda)(0.025 \mu m/\lambda)(1.8 \text{ fF} / \mu m)$  $(1.0)^2 (1.0 \text{ GHz})$  $C_{\text{logic}} = (50 \times 10^6)(12 \lambda)(0.025 \mu m / \lambda)(1.8 \text{ fF} / \mu m) = 27 \text{ nF}$  $C_{\text{mem}} = (950 \times 10^6)(4 \lambda)(0.025 \mu m / \lambda)(1.8 \text{ fF} / \mu m) = 171 \text{ nF}$  $P_{\text{dynamic}} = \pmb{\left[ 0.1 C_{\text{logic}} + 0.02 C_{\text{mem}} \right] \text{(1.0)}^2 \text{(1.0 GHz)} \text{ =} 6.1 \text{ W}}$ 



#### Dynamic Power Reduction

 $P_{\text{switching}} = \alpha C V_{DD}^2 f$ 

#### Try to minimize:

Activity factor

**Capacitance** 

Clock Gating

Voltage Scaling

Frequency Scaling: Dynamic Voltage and Frequency Scaling (DVFS)

Power Gating:

Multi-Voltage Design:

Data and Instruction Compression:

Pipeline Balancing:

Clock Tree Optimization

Low Power Design Methodologies

**7: Power 13**

#### Clock Gating

The best way to reduce the activity is to turn off the clock to registers in unused blocks

Saves clock activity ( $\alpha = 1$ )

Eliminates all switching activity in the block

Requires determining if block will be used



#### **Capacitance**

- $\triangleright$  Gate capacitance
- $\triangleright$  Fewer stages of logic
- $\triangleright$  Small gate sizes
- $\triangleright$  Wire capacitance
- Good floorplanning to keep communicating blocks close to each other
- $\triangleright$  Drive long wires with inverters or buffers rather than complex gates



## Voltage / Frequency

Run each block at the lowest possible voltage and frequency that meets performance requirements

Voltage Domains

Provide separate supplies to different blocks

Level converters required when crossing

from low to high  $V_{DD}$  domains

Dynamic Voltage Scaling Adjust  $V_{DD}$  and f according to workload





**7: Power 16**

## Static Power

Static power is consumed even when chip is quiescent. Leakage draws power from nominally OFF devices Ratio circuits burn power in fight between ON transistors



#### Leakage Control

Leakage and delay trade off

Aim for low leakage in sleep and low delay in active mode To reduce leakage:

Increase V<sub>t</sub>: multiple V<sub>t</sub>

• Use low  $V_t$  only in critical circuits

Increase V<sub>s</sub>: stack effect

• *Input vector control* in sleep

Decrease  $V<sub>b</sub>$ 

- *Reverse body bias* in sleep
- Or forward body bias in active mode

#### Power Gating

Turn OFF power to blocks when they are idle to save leakage

Use virtual  $V_{DD}$  ( $V_{DDV}$ ) Gate outputs to prevent invalid logic levels to next block



Isolation<br>Voltage drop across sleep transistor degrades performance during normal operation Size the transistor wide enough to minimize impact Switching wide sleep transistor costs dynamic power Only justified when circuit sleeps long enough